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SUBMISSION TYPE:		NEW ASSIGNMENT		
NATURE OF CONVEYANCE:			ASSIGNMENT	
CONVEYING PARTY	DATA		·	
Name Execution Date				Execution Date
Mr. Yaocheng Liu				04/20/2008
Mr. Devendra Kumar	Sadana			04/17/2008
Mr. Kern Rim				04/15/2008
RECEIVING PARTY D	ΑΤΑ			
Name:		DNAL B	BUSINESS MACHINES CORPORATION	
Street Address:	New Orchard	Rd		
City:	Armonk			
State/Country:	NEW YORK			
Postal Code:				
PROPERTY NUMBERS Total: 1 Property Type Number 12108917				
Property Ty	/pe		Number	
		12108	3917	
CORRESPONDENCE DATA				
CORRESPONDENCE DATA Fax Number: (631)665-5101				
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.				
Phone: 631 665 5169				
Email: DICO.HALAJIAN@THLLP.NET Correspondent Name: THORNE & HALAJIAN, LLP				
Address Line 1: 111 WEST MAIN STREET				
Address Line 4: BAY SHORE, NEW YORK 11706				
ATTORNEY DOCKET NUMBER:			YOR920070743	
NAME OF SUBMITTER:			Dicran Halajian	
Total Attachments: 6 source=YOR920070743-Assignment#page1.tif				

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PATENT REEL: 020851 FRAME: 0525

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Docket Number: YOR920070743US1

ASSIGNMENT

Whereas we,

- (1) Yaocheng Liu
- (2) Devendra Kumar Sadana
- (3) Kern Rim
- (4)

of White Plains, New York of Pleasantville, New York of Yorktown Heights, New York of

have invented certain improvements in:

LOCALIZED STRAIN RELAXATION FOR STRAINED SI DIRECTLY ON INSULATOR

and excluded a United States patent application therefore on the following date(s):

(1)	04/20/2008 (Date)	-
(2)	(Date)	
(3)	(Date)	_
(4)	(Date)	-

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and in all foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

	·		Docket Number: YOR920070743U	51
SIGN	ED:			
	LOCATION	<u>[)ATE</u>	SIGNATURE	
(1)	White Plains, New York	04/20/2008	Mains	
(2)	Pleasantville, New York			
(3)	Yorktown Heights, New York			
(4)			· · ·	

ASSIGNMENT

Whereas we,

(1)	Yaocheng Liu	of White Plains, New York
(2)	Devendra Kumar Sadana	of Pleasantville, New York
(3)	Kern Rim	of Yorktown Heights, New York
(4)		of

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and excluded a United States patent application therefore on the following date(s):

(1)	(Date)	÷ R
(2)	(Date)	4/17/08
(3)	(Date)	
(4)	(Date)	······

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Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and in all foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

SIGNED:

	LOCATION	DATE	SIGNATURE
(1)	White Plains, New York	. <u></u>	
(2)	Pleasantville, New York	417/08	Downlose Know Salame
(3)	Yorktown Heights, New York		
(4)			

ASSIGNMENT

Whereas we,

(1)	Yaocheng Liu	of White Plains, New York
(2)	Devendra Kumar Sadana	of Pleasantville, New York
(3)	Kern Rim	of Yorktown Heights, New York
(4)		of

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SIGNED:

	LOCATION	DATE	SIGNATURE
(1)	White Plains, New York		<u> </u>
(2)	Pleasantville, New York		
(3)	Yorktown Heights, New Yor k	4/15/2008	- Un h.

(4)

RECORDED: 04/24/2008